



## Declaration of Conformity

**Product:** OSDK Expansion Module  
**Model Number:** M300-OEXP01  
**Manufacturer's Name:** SZ DJI TECHNOLOGY CO., LTD.  
**Manufacturer's Address:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China

We, SZ DJI TECHNOLOGY CO., LTD., declare under our sole responsibility that the above referenced product is in conformity with the applicable requirements of the following directives:

EMC Directive: 2014/30/EU  
RoHS Recast Directive: 2011/65/EU (EU)2015/863  
WEEE Directive: 2012/19/EU  
REACH Regulation: 2006/1907/EC

Conformity with these directives has been assessed for this product by demonstrating compliance to the following harmonized standards and/or regulations:

<b>EMC</b>	EN 55032:2015      EN 55035:2017 EN 61000-3-2:2014      EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Signed for and on behalf of: SZ DJI TECHNOLOGY CO., LTD.

Place: Shenzhen, China

Date: 2022-07-21

Name: Gary Zeng

Position: Certification Manager

Signature:

## Декларация за съответствие

**Продукт:** OSDK Expansion Module  
**Модел №:** M300-OEXP01  
**Производител:** SZ DJI TECHNOLOGY CO., LTD.  
**Адрес на производителя:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, гр. Гуандун, Китай

Ние, SZ DJI TECHNOLOGY CO., LTD., декларираме на собствена отговорност, че горепосоченият продукт отговаря на приложимите изисквания на следните директиви:

Директивата за електромагнитна съвместимост: 2014/30/EC

Директивата относно ограничението за употребата на определени опасни вещества в електрическото и електронното оборудване: 2011/65/EC (EC)2015/863

Директива за ОЕЕО: 2012/19/EC

Регламент относно регистрацията, оценката, разрешаването и ограничаването на химикали: 2006/1907/EK

Съответствието на продукта с тези директиви е оценено чрез демонстриране на съответствие със следните хармонизирани стандарти и/или разпоредби:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>Ограничение за употребата на определени опасни вещества в електрическото и електронното оборудване</b>	2011/65/EC (EC)2015/863
<b>ОЕЕО</b>	2012/19/EC
<b>Регистрация, оценка, разрешаване и ограничаване на химикали</b>	2006/1907/EK

Подписано за и от името на: SZ DJI TECHNOLOGY CO., LTD.

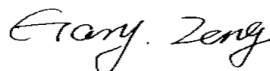
Населено място: гр. Шенжен, Китай

Дата: 2022-07-21 г.

Име: Gary Zeng

Длъжност: Certification Manager

Подпис:



## Prohlášení o shodě

**Výrobek:** OSDK Expansion Module  
**Číslo modelu:** M300-OEXP01  
**Název výrobce:** SZ DJI TECHNOLOGY CO., LTD.  
**Adresa výrobce:** 14. poschodí, West Wing, Skyworth Semiconductor Design Building č. 18  
Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Čína

Společnost SZ DJI TECHNOLOGY CO., LTD. prohlašuje, že je její výhradní zodpovědností, aby výše uvedený výrobek splňoval příslušné požadavky následujících směrnic:

Směrnice EMC: 2014/30/EU  
Revidovaná směrnice RoHS: 2011/65/EU (EU)2015/863  
Směrnice WEEE: 2012/19/EU  
Nařízení REACH: 2006/1907/ES

Shoda výrobku s těmito směrnicemi byla posouzena tak, že bylo prokázáno, že splňuje požadavky následujících harmonizovaných standardů nebo nařízení:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/ES

Podepsáno za a jménem společnosti: SZ DJI TECHNOLOGY CO., LTD.

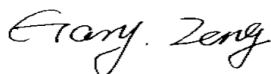
Místo: Shenzhen, Čína

Datum: 2022-07-21

Název: Gary Zeng

Pozice: Certification Manager

Podpis:



## Erklæring af overensstemmelse

**Produkt:** OSDK Expansion Module  
**Modelnummer:** M300-OEXP01  
**Producentens navn:** SZ DJI TECHNOLOGY CO., LTD.  
**Producentens adresse:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Kina

Vi, SZ DJI TECHNOLOGY CO., LTD., erklærer som eneste ansvarlige, at det ovenfor nævnte produkt er i overensstemmelse med de gældende krav i følgende direktiver:

EMC-direktivet om elektromagnetisk kompatibilitet: 2014/30/EU  
RoHS-direktivet om begrænsning af anvendelsen af visse farlige stoffer i elektrisk og elektronisk udstyr: 2011/65/EU (EU)2015/863  
Direktiv om affald af elektrisk og elektronisk udstyr (WEEE): 2012/19/EU  
Forordning om registrering, vurdering og godkendelse af samt begrænsninger for kemikalier (REACH): 2006/1907/EC

Overensstemmelse med disse direktiver er blevet vurderet for produktet ved at påvise overholdelse af følgende harmoniserede standarder og/eller forordninger:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Underskrevet for og på vegne af: SZ DJI TECHNOLOGY CO., LTD.

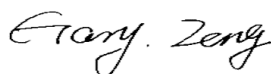
Sted: Shenzhen, Kina

Dato: 2022-07-21

Navn: Gary Zeng

Stilling: Certification Manager

Underskrift:



## Konformitätserklärung

**Produkt:** OSDK Expansion Module  
**Modell-Nr.:** M300-OEXP01  
**Herstellername:** SZ DJI TECHNOLOGY CO., LTD.  
**Adresse des Herstellers:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China

Wir, SZ DJI TECHNOLOGY CO., LTD., erklären in unserer alleinigen Verantwortung, dass das oben genannte Produkt den geltenden Anforderungen der folgenden Richtlinien entspricht:

EMC-Richtlinie: 2014/30/EU  
RoHS-Richtlinie, Neufassung: 2011/65/EU (EU)2015/863  
WEEE-Richtlinie: 2012/19/EU  
REACH-Verordnung: 2006/1907/EG

Die Erfüllung dieser Richtlinien wurde für das Produkt geprüft, indem die Einhaltung der folgenden harmonisierten Normen und/oder Vorschriften nachgewiesen wurde:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EG

Unterzeichnet für und im Namen von: SZ DJI TECHNOLOGY CO., LTD.

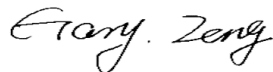
Ort: Shenzhen, China

Datum: 2022-07-21

Name: Gary Zeng

Position: Certification Manager

Unterschrift:



## Δήλωση Συμμόρφωσης

**Προϊόν:** OSDK Expansion Module  
**Αριθμός μοντέλου:** M300-OEXP01  
**Επωνυμία κατασκευαστή:** SZ DJI TECHNOLOGY CO., LTD.  
**Διεύθυνση κατασκευαστή:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Κίνα

Εμείς, η SZ DJI TECHNOLOGY CO., LTD., δηλώνουμε με αποκλειστική ευθύνη μας ότι το προαναφερόμενο προϊόν συμμορφώνεται με τις ισχύουσες απαιτήσεις των παρακάτω οδηγιών:

Οδηγία για την ηλεκτρομαγνητική συμβατότητα (EMC): 2014/30/EE

Οδηγία (αναδιατύπωση) για τον περιορισμό των επικίνδυνων ουσιών (RoHS):

2011/65/EE (EE)2015/863

Οδηγία για τα απόβλητα ηλεκτρικού και ηλεκτρονικού εξοπλισμού (WEEE):

2012/19/EE

Κανονισμός για την καταχώριση, αξιολόγηση και έγκριση χημικών ουσιών (REACH):

2006/1907/EK

Η συμμόρφωση προς τις οδηγίες αυτές έχει αξιολογηθεί για το προϊόν, αποδεικνύοντας συμμόρφωση προς τα ακόλουθα εναρμονισμένα πρότυπα ή/και κανονισμούς:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EE (EE)2015/863
<b>WEEE</b>	2012/19/EE
<b>REACH</b>	2006/1907/EK

Υπογραφή για και εξ ονόματος της: SZ DJI TECHNOLOGY CO., LTD.

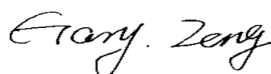
Τόπος: Shenzhen, Κίνα

Ημερομηνία: 2022-07-21

Όνομα: Gary Zeng

Θέση: Certification Manager

Υπογραφή:



## Declaración de Conformidad

**Producto:** OSDK Expansion Module  
**Número de modelo:** M300-OEXP01  
**Nombre del fabricante:** SZ DJI TECHNOLOGY CO., LTD.  
**Dirección del fabricante:** 14th floor, West Wing, Skyworth Semiconductor Design Building,  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China

Nosotros, SZ DJI TECHNOLOGY CO., LTD., declaramos bajo nuestra exclusiva responsabilidad que el producto mencionado anteriormente cumple con los requisitos aplicables de las siguientes directivas:

Directiva EMC: 2014/30/UE  
Directiva refundida RoHS: 2011/65/UE (UE)2015/863  
Directiva WEEE: 2012/19/UE  
Reglamento REACH: 2006/1907/CE

Se ha evaluado para el producto la conformidad con estas directivas al demostrar el cumplimiento de las siguientes normas y/o regulaciones armonizadas:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/UE (UE)2015/863
<b>WEEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/CE

Firmado por y en representación de: SZ DJI TECHNOLOGY CO., LTD.  
Lugar: Shenzhen, China Fecha: 2022-07-21  
Nombre: Gary Zeng Posición: Certification Manager

Firma: 

## Vastavusdeklaratsioon

**Toode:** OSDK Expansion Module  
**Mudeli number:** M300-OEXP01  
**Tootja nimetus:** SZ DJI TECHNOLOGY CO., LTD.  
**Tootja aadress:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Hiina

Meie, SZ DJI TECHNOLOGY CO., LTD., kinnitame oma ainuvastutusel, et ülalnimetatud toode vastab järgmiste direktiivide kohaldatavatele nõuetele:

2013/56/EU

Elektromagnetilise ühilduvuse direktiiv: 2014/30/EL  
Ohtlike ainete kasutamise piiramise uuestisõnastatud direktiiv: 2011/65/EL (EL)2015/863  
Elektri- ja elektroonikajäätmete direktiiv: 2012/19/EL  
REACH-määrus: 2006/1907/EÜ

Toote kooskõla nendele direktiividega on hinnatud, tõendades selle vastavust järgmistele ühtlustatud standarditele ja/või normidele:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>Ohtlike ainete kasutamise piiramist käsitlev direktiiv</b>	2011/65/EL (EL)2015/863
<b>Elektri- ja elektroonikajäätmed</b>	2012/19/EL
<b>REACH</b>	2006/1907/EÜ

Alla kirjutanud (kelle poolt ja nimel): SZ DJI TECHNOLOGY CO., LTD.

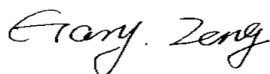
Koht: Shenzhen, Hiina

Kuupäev: 2022-07-21

Nimi: Gary Zeng

Ametikoht: Certification Manager

Allkiri:





## Vaatimustenmukaisuusvakuutus

**Tuote:** OSDK Expansion Module  
**Mallinumero:** M300-OEXP01  
**Valmistajan nimi:** SZ DJI TECHNOLOGY CO., LTD.  
**Valmistajan osoite:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Kiina

Me, SZ DJI TECHNOLOGY CO., LTD., vakuutamme olevamme yksinomaisessa vastuussa siitä, että edellä mainittu tuote on seuraavien sovellettavien direktiivien mukainen:

EMC-direktiivi: 2014/30/EU  
RoHS-direktiivi (uudelleenlaadittu): 2011/65/EU (EU)2015/863  
WEEE-direktiivi: 2012/19/EU  
REACH-asetus: 2006/1907/EC

Näiden direktiivien mukaisuus on arvioitu tuotteen osalta osoittamalla, että tuote on seuraavien yhdenmukaistettujen standardien ja/tai asetusten mukainen:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Puolesta allekirjoittanut: SZ DJI TECHNOLOGY CO., LTD.

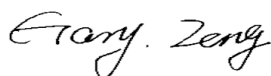
Paikka: Shenzhen, Kiina

Päiväys: 2022-07-21

Nimi: Gary Zeng

Asema: Certification Manager

Allekirjoitus:



## Déclaration de conformité

**Produit :** OSDK Expansion Module  
**Numéro de modèle :** M300-OEXP01  
**Nom du fabricant :** SZ DJI TECHNOLOGY CO., LTD.  
**Adresse du fabricant :** 14e étage, Aile ouest, Skyworth Semiconductor Design Building, 18 Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Chine

Par la présente, nous, SZ DJI TECHNOLOGY CO., LTD., déclarons sous notre seule responsabilité que le produit référencé ci-dessus est conforme aux exigences applicables des directives suivantes :

Directive ECM : 2014/30/UE  
Directive LdSD refondue : 2011/65/UE (UE)2015/863  
Directive DEEE : 2012/19/UE  
Règlement REACH : 2006/1907/CE

La conformité à ces directives a été évaluée pour le produit en démontrant la conformité aux normes et/ou réglementations harmonisées suivantes :

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>LdSD</b>	2011/65/UE (UE)2015/863
<b>DEEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/CE

Signé pour et au nom de : SZ DJI TECHNOLOGY CO., LTD.

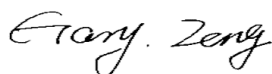
Lieu : Shenzhen, Chine

Date : 2022-07-21

Nom : Gary Zeng

Fonction : Certification Manager

Signature :



## Dearbhú Comhréireachta

**Táirge:** OSDK Expansion Module  
**Uimhir Leagain:** M300-OEXP01  
**Ainm an Déantúsóra:** *SZ DJI TECHNOLOGY CO., LTD.*  
**Seoladh an Déantúsóra:** *14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China*

Dearbhaímid, *SZ DJI TECHNOLOGY CO., LTD.*, faoinár bhfreagracht amháin go bhfuil an táirge a dtagraítear dó thuas i gcomhréir leis na riachtanais infheidhmithe de na treoracha seo a leanas:

Treoir CL: 2014/30/AE  
Treoir athraithe ó bhonn RoHS: 2011/65/AE (AE)2015/863  
Treoir DTLL: 2012/19/AE  
Rialachán REACH: 2006/1907/CE

Tá measúnú déanta ar chomhréireacht leis na treoracha seo i dtaca leis an táirge trí chomhlíontacht na gcaighdeán agus/nó na rialachán comhchuibhithe a thaispeáint:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/AE (AE)2015/863
<b>DTLL</b>	2012/19/AE
<b>REACH</b>	2006/1907/CE

Sínithe thar ceann agus ar son: *SZ DJI TECHNOLOGY CO., LTD.*

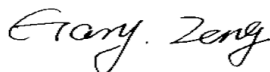
Láthair: Shenzhen, An tSín

Dáta: 2022-07-21

Ainm: Gary Zeng

Post: Certification Manager

Síniú:



## Izjava o sukladnosti

**Proizvod:** OSDK Expansion Module  
**Broj modela:** M300-OEXP01  
**Naziv proizvođača:** SZ DJI TECHNOLOGY CO., LTD.  
**Adresa proizvođača:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Kina

Mi, tvrtka SZ DJI TECHNOLOGY CO., LTD., izjavljujemo na našu isključivu odgovornost da je gore navedeni proizvod u skladu s primjenjivim zahtjevima sljedećih direktiva:

Direktiva EMC: 2014/30/EU  
Preinačena direktiva RoHS: 2011/65/EU (EU)2015/863  
Direktiva WEEE: 2012/19/EU  
Uredbe REACH: 2006/1907/EC

Sukladnost s ovim direktivama ocijenjena je za proizvod pokazujući usklađenost sa sljedećim harmoniziranim standardima i/ili propisima:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Potpisano za i u ime: SZ DJI TECHNOLOGY CO., LTD.

Mjesto: Shenzhen, Kina

Datu: 2022-07-21

Ime: Gary Zeng

Funkcija: Certification Manager

Potpis:



## Megfelelőségi nyilatkozat

**Termék:** OSDK Expansion Module

**Típuszám:** M300-OEXP01

**Gyártó neve:** SZ DJI TECHNOLOGY CO., LTD.

**Gyártó címe:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Kína

Alulírott SZ DJI TECHNOLOGY CO., LTD. kizárólagos felelősséggel kijelentjük, hogy a fent nevezett termék a következő irányelvek vonatkozó előírásainak megfelel:

EMC (elektromágneses összeférhetőségről szóló) irányelv: 2014/30/EU

RoHS (veszélyes anyagok alkalmazását korlátozó) átdolgozott irányelv: 2011/65/EU  
(EU)2015/863

WEEE (az elektromos és elektronikus berendezések hulladékairól szóló) irányelv:  
2012/19/EU

REACH (a vegyi anyagok regisztrálásáról, értékeléséről, engedélyezéséről és korlátozásáról szóló) irányelv: 2006/1907/EK

A termék említett irányelveknek való megfelelésének értékelése a következő harmonizált szabványoknak és/vagy rendeleteknek való megfelelésig igazolásával történt:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EK

A nyilatkozatot az alábbi fél nevében és megbízásából írták alá: SZ DJI TECHNOLOGY CO., LTD.

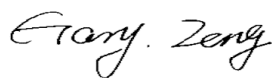
Hely: Shenzhen, Kína

Dátum: 2022-07-21

Név: Gary Zeng

Beosztás: Certification Manager

Aláírás:



## Yfirlýsing um samræmi

**Vara:** OSDK Expansion Module  
**Gerð númer:** M300-OEXP01  
**Heiti framleiðanda:** SZ DJI TECHNOLOGY CO., LTD.  
**Heimilisfang framleiðanda:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China

Við, SZ DJI TECHNOLOGY CO., LTD., lýsum því yfir að það er alfarið á okkar ábyrgð að varan sem er skilgreind hér að ofan sé í samræmi við þær kröfur sem settar eru fram og eiga við og eru í eftirfarandi tilskipunum:

EMC Tilskipun: 2014/30/EU  
RoHS Endurskoðuð tilskipun: 2011/65/EU (EU)2015/863  
WEEE Tilskipun: 2012/19/EU  
REACH Reglugerð: 2006/1907/EC

Uppfylling skilyrða þessara tilskipana hafa verið metin fyrir vöruna með því að sýna fram á samræmi við eftirfarandi samræmda staðla og/eða reglugerðir:

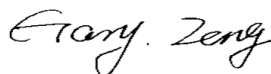
<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Undirritað af og fyrir hönd: SZ DJI TECHNOLOGY CO., LTD.

Staður: Shenzhen, China Dags:2022-07-21

Nafn: Gary Zeng Staða: Certification Manager

Undirskrift:



## Dichiarazione di conformità

**Prodotto:** OSDK Expansion Module  
**Numero di modello:** M300-OEXP01  
**Nome del produttore:** SZ DJI TECHNOLOGY CO., LTD.  
**Indirizzo del produttore:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China

SZ DJI TECHNOLOGY CO., LTD., dichiara che il prodotto sopra indicato è conforme ai requisiti applicabili dalle direttive seguenti:

Direttiva EMC: 2014/30/UE  
Direttiva rifiuta RoHS: 2011/65/UE (UE)2015/863  
Direttiva RAEE: 2012/19/UE  
Regolamento REACH: 2006/1907/CE

La conformità a queste direttive è stata valutata sulla base della compatibilità del prodotto con le seguenti normative e/o regolamenti armonizzati:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/UE (UE)2015/863
<b>RAEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/CE

Firmato a nome e per conto di: SZ DJI TECHNOLOGY CO., LTD.

Luogo: Shenzhen, Cina

Data: 2022-07-21

Nome: Gary Zeng

Posizione: Certification Manager

Firma: 

## Atitikties deklaracija

**Gaminys:** OSDK Expansion Module  
**Modelio numeris:** M300-OEXP01  
**Gamintojas:** SZ DJI TECHNOLOGY CO., LTD.  
**Gamintojo adresas:** 14th floor, West Wing, Skyworth Semiconductor Design Building No. 18, Gaixin South, 4th Ave, Nanshan District, Shenzhen, Guangdong, China (Kinija)

Prisiimdami visą atsakomybę, mes, SZ DJI TECHNOLOGY CO., LTD., patvirtiname, kad nurodyti gaminiai atitinka jiems taikomų toliau nurodytų direktyvų ir reglamentų reikalavimus:

Elektromagnetinio suderinamumo direktyva: 2014/30/ES  
Pavojingų medžiagų naudojimo elektros ir elektroninėje įrangoje apribojimo direktyva: 2011/65/ES (ES)2015/863  
Elektros ir elektroninės įrangos atliekų tvarkymo direktyva: 2012/19/ES  
Cheminių medžiagų registracijos, įvertinimo, autorizacijos ir apribojimų reglamentas: 2006/1907/EB

Minėtų gaminių atitikties šių direktyvų ir reglamentų reikalavimams buvo tikrinama taikant šiuos darniuosius standartus ir (arba) reglamentus:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>Pavojingų medžiagų naudojimo elektros ir elektroninėje įrangoje apribojimai</b>	2011/65/ES (ES)2015/863
<b>Elektros ir elektroninės įrangos atliekų tvarkymas</b>	2012/19/ES
<b>Cheminių medžiagų registracija, įvertinimas, autorizacija ir apribojimai</b>	2006/1907/EB

Pasirašyta ir patvirtinta SZ DJI TECHNOLOGY CO., LTD. vardu

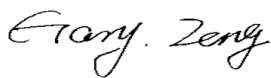
Vieta: Šendženas, Kinija

Data: 2022-07-21

Vardas, pavardė: Gary Zeng

Pareigos: Certification Manager

Parašas:





## Atbilstības deklarācija

**Produkts:** OSDK Expansion Module  
**Modeļa numurs:** M300-OEXP01  
**Ražotāja nosaukums:** SZ DJI TECHNOLOGY CO., LTD.  
**Ražotāja adrese:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Ķīna

Mēs, SZ DJI TECHNOLOGY CO., LTD., ar pilnu atbildību paziņojam, ka iepriekš nosauktais produkts atbilst piemērojamajām šādu direktīvu prasībām:

EMS direktīva: 2014/30/ES  
RoHS pārstrādātā direktīva: 2011/65/ES (ES)2015/863  
EEIA direktīva: 2012/19/ES  
REACH regula: 2006/1907/EK

Produkta atbilstība šīm direktīvām ir novērtēta, pierādot atbilstību šādiem harmonizētajiem standartiem un/vai regulām:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/ES (ES)2015/863
<b>EEIA</b>	2012/19/ES
<b>REACH</b>	2006/1907/EK

Paraksts tālāk norādītā uzņēmuma labā un vārdā: SZ DJI TECHNOLOGY CO., LTD.

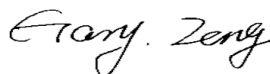
Vieta: Shenzhen, Ķīna

Datums: 2022-07-21

Vārds, uzvārds: Gary Zeng

Amats: Certification Manager

Paraksts:



## Dikjarazzjoni ta' Konformità

**Prodott:** OSDK Expansion Module  
**Numru tal-Mudell:** M300-OEXP01  
**Isem tal-Manifattur:** SZ DJI TECHNOLOGY CO., LTD.  
**Indirizz tal-Manifattur:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Iċ-Ċina

Aħna, SZ DJI TECHNOLOGY CO., LTD., niddikjaraw fir-responsabbiltà unika tagħna li l-prodott imsemmi hawn fuq jikkonforma mar-rekwiżiti applikabbli tad-direttivi li ġejjin:

Direttiva EMC: 2014/30/UE  
Direttiva Riformulata RoHS: 2011/65/UE (UE)2015/863  
Direttiva WEEE: 2012/19/UE  
Regolament REACH: 2006/1907/KE

Il-konformità ma' dawn id-direttivi ġiet valutata għall-prodott billi ntweriet konformità mal-istandards u/jew ir-regolamenti armonizzati li ġejjin:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/UE (UE)2015/863
<b>WEEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/KE

Iffirmat għal u f'isem: SZ DJI TECHNOLOGY CO., LTD.

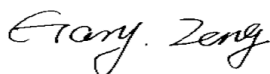
Post: Shenzhen, Iċ-Ċina

Data: 2022-07-21

Isem: Gary Zeng

Pożizzjoni: Certification Manager

Firma:



## Conformiteitsverklaring

**Product:** OSDK Expansion Module  
**Modelnummer:** M300-OEXP01  
**Naam van de fabrikant:** *SZ DJI OSMO TECHNOLOGY CO., LTD.*  
**Adres fabrikant:** *14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China*

Wij, *SZ DJI TECHNOLOGY CO., LTD.*, verklaren op eigen verantwoordelijkheid dat het hierboven genoemde product in overeenstemming is met de toepasselijke vereisten van de volgende richtlijnen:

EMC Richtlijn: 2014/30/EU  
RoHS Herzene richtlijn: 2011/65/EU (EU)2015/863  
WEEE Richtlijn: 2012/19/EU  
BEREIKEN Regelgeving: 2006/1907/EG

De conformiteit met deze richtlijnen is voor het product beoordeeld door aan te tonen dat het voldoet aan de volgende geharmoniseerde normen en/of voorschriften:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>BEREIKEN</b>	2006/1907/EG

Ondertekend voor en namens: *SZ DJI TECHNOLOGY CO., LTD.*

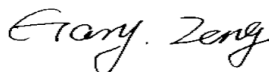
Plaats: Shenzhen, China

Datum: 2022-07-21

Naam: Gary Zeng

Positie: Certification Manager

Handtekening:



## Deklaracja zgodności

**Produkt:** OSDK Expansion Module  
**Numer modelu:** M300-OEXP01  
**Nazwa producenta:** SZ DJI TECHNOLOGY CO., LTD.  
**Adres producenta:** Skyworth Semiconductor Design Building No. 18, West Wing, 14 piętro, Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Chiny

Firma SZ DJI TECHNOLOGY CO., LTD. zaświadcza na swoją wyłączną odpowiedzialność, że przywołany powyżej wyrób jest zgodny z obowiązującymi wymaganiami następujących dyrektyw:

Dyrektywa EMC: 2014/30/UE  
Zmieniona dyrektywa RoHS: 2011/65/UE (UE)2015/863  
Dyrektywa WEEE: 2012/19/UE  
Rozporządzenie REACH: 2006/1907/WE

Zgodność produktu z tymi dyrektywami została oceniona poprzez wykazanie zgodności z następującymi normami zharmonizowanymi i/lub przepisami:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/UE (UE)2015/863
<b>WEEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/WE

Podpisano dla i w imieniu: SZ DJI TECHNOLOGY CO., LTD.

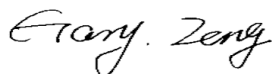
Miejsce: Shenzhen, Chiny

Data: 2022-07-21

Imię i nazwisko: Gary Zeng

Stanowisko: Certification Manager

Podpis:



## Declaração de Conformidade

**Produto:** OSDK Expansion Module  
**Número do modelo:** M300-OEXP01  
**Nome do fabricante:** SZ DJI TECHNOLOGY CO., LTD.  
**Morada do fabricante:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District District, Shenzhen, Guangdong, China

Nós, SZ DJI TECHNOLOGY CO., LTD., declaramos sob a nossa exclusiva responsabilidade que o produto acima referido está em conformidade com os requisitos aplicáveis das seguintes diretivas:

Diretiva CEM: 2014/30/UE  
Diretiva reformulada RoHS: 2011/65/UE (UE)2015/863  
Diretiva REEE: 2012/19/UE  
Regulamento REACH: 2006/1907/CE

A conformidade com estas diretivas foi avaliada para o produto, demonstrando conformidade com as seguintes normas e/ou regulamentos harmonizados:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>Rohs</b>	2011/65/UE (UE)2015/863
<b>REEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/CE

Assinado por e em nome de: SZ DJI TECHNOLOGY CO., LTD.

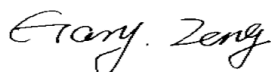
Local: Shenzhen, China

Data: 2022-07-21

Nome: Gary Zeng

Cargo: Certification Manager

Assinatura:



## Declarație de conformitate

**Produs:** OSDK Expansion Module  
**Număr model:** M300-OEXP01  
**Denumire producător:** SZ DJI TECHNOLOGY CO., LTD.  
**Adresă producător:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China

Subscrisa, SZ DJI TECHNOLOGY CO., LTD., declarăm pe propria răspundere că produsul mai sus menționat este în conformitate cu cerințele aplicabile din următoarele directive:

Directiva EMC: 2014/30/UE  
Directiva modificată: RoHS 2011/65/UE (UE)2015/863  
Directiva DEEE: 2012/19/UE  
Reglementarea REACH: 2006/1907/CE

Conformitatea cu aceste directive a fost evaluată pentru produs prin demonstrarea respectării următoarelor standarde și / sau reglementări armonizate:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/UE (UE)2015/863
<b>DEEE</b>	2012/19/UE
<b>REACH</b>	2006/1907/CE

Semnat pentru și în numele: SZ DJI TECHNOLOGY CO., LTD.

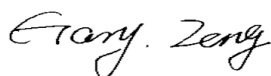
Locul: Shenzhen, China

Data: 2022-07-21

Nume: Gary Zeng

Funcția: Certification Manager

Semnătură:



## Vyhlásenie o zhode

**Produkt:** OSDK Expansion Module  
**Číslo modelu:** M300-OEXP01  
**Názov výrobcu:** SZ DJI TECHNOLOGY CO., LTD.  
**Adresa výrobcu:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaoxin South 4th Ave, Nanshan District, Šen-čen, Kuang-tung, Čína

My, spoločnosť SZ DJI TECHNOLOGY CO., LTD., na vlastnú zodpovednosť prehlasujeme, že vyššie uvedený produkt je v zhode s platnými požiadavkami nasledujúcich smerníc:

Smernica EMC: 2014/30/EÚ  
Prepracovaná smernica RoHS: 2011/65/EÚ (EÚ)2015/863  
Smernica WEEE: 2012/19/EÚ  
Nariadenie REACH: 2006/1907/ES

Zhoda s týmito smernicami bola pre produkt posúdená preukázaním súladu s nasledujúcimi harmonizovanými normami alebo predpismi:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EÚ (EÚ)2015/863
<b>WEEE</b>	2012/19/EÚ
<b>REACH</b>	2006/1907/ES

Podpísané za a v mene: SZ DJI TECHNOLOGY CO., LTD.

Miesto: Šen-čen, Čína

Dátum: 2022-07-21

Meno: Gary Zeng

Pozícia: Certification Manager

Podpis: 

## Izjava o skladnosti

**Izdelek:** OSDK Expansion Module  
**Številka modela:** M300-OEXP01  
**Ime proizvajalca:** SZ DJI TECHNOLOGY CO., LTD.  
**Naslov proizvajalca:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Kitajska

Mi, podjetje SZ DJI TECHNOLOGY CO., LTD., z izključno odgovornostjo izjavljamo, da je zgoraj navedeni izdelek skladen z veljavnimi zahtevami naslednjih direktiv:

Direktiva o elektromagnetni združljivosti (EMC): 2014/30/EU  
Prenovljena direktiva o omejevanju uporabe nevarnih snovi (RoHS): 2011/65/EU  
(EU)2015/863  
Direktiva OEEO: 2012/19/EU  
Uredba o registraciji, evalvaciji, avtorizaciji in omejevanju kemikalij (REACH):  
2006/1907/ES

Skladnost s temi direktivami je bila za izdelek ocenjena z izpolnjevanjem naslednjih usklajenih standardov in/ali predpisov:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>OEEO</b>	2012/19/EU
<b>REACH</b>	2006/1907/ES

Podpisal/-a za in v imenu: SZ DJI TECHNOLOGY CO., LTD.

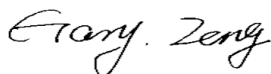
Kraj: Shenzhen, Kitajska

Datum: 2022-07-21

Ime in priimek: Gary Zeng

Položaj: Certification Manager

Podpis:





## Försäkran om överensstämmelse

**Produkt:** OSDK Expansion Module  
**Modellnummer:** M300-OEXP01  
**Tillverkarens namn:** SZ DJI TECHNOLOGY CO., LTD.  
**Tillverkarens adress:** 14th floor, West Wing, Skyworth Semiconductor Design Building NO.18  
Gaixin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Kina

Vi, SZ DJI TECHNOLOGY CO., LTD., intygar under eget ansvar att produkten som nämns ovan följer de tillämpliga kraven i följande direktiv:

EMC-direktivet: 2014/30/EU  
RoHS-direktivet (omarbetad version): 2011/65/EU (EU)2015/863  
WEEE-direktivet: 2012/19/EU  
REACH-förordningen: 2006/1907/EC

Förenligheten med dessa direktiv har bedömts genom att uppvisa produkt efterlevnad enligt följande harmoniserade standarder och/eller förordningar:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Undertecknat för och på uppdrag av: SZ DJI TECHNOLOGY CO., LTD.


Plats: Shenzhen, Kina

Datum: 2022-07-21

Namn: Gary Zeng

Befattning: Certification Manager

Undertecknande:



## Uygunluk Beyanı

**Ürün:** OSDK Expansion Module  
**Model Numarası:** M300-OEXP01  
**Üreticinin Adı:** SZ DJI TECHNOLOGY CO., LTD.  
**Üretici Adresi:** 14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, Çin

Biz, SZ DJI TECHNOLOGY CO., LTD., yukarıda belirtilen ürünün aşağıda belirtilen direktiflerin geçerli gerekliliklerine uygun olduğunu yalnız kendi sorumluluğumuz altında beyan ederiz:

EMC Direktifi: 2014/30/EU  
RoHS Değişiklik Direktifi: 2011/65/EU (EU)2015/863  
WEEE Direktifi: 2012/19/EU  
REACH Yönetmeliği: 2006/1907/EC

Aşağıdaki ortak standartlara ve/veya yönetmeliklere uygun olarak bu ürün bu direktiflere uygunluk değerlendirilmiştir:

<b>EMC</b>	EN 55032:2015 EN 55035:2017 EN 61000-3-2:2014 EN 61000-3-3:2013
<b>RoHS</b>	2011/65/EU (EU)2015/863
<b>WEEE</b>	2012/19/EU
<b>REACH</b>	2006/1907/EC

Şunun adına ve namına imzalanmıştır: SZ DJI TECHNOLOGY CO., LTD.

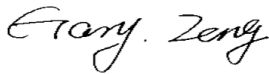
Yer: Shenzhen, Çin

Tarih: 2022-07-21

İsim: Gary Zeng

Görev: Certification Manager

İmza:





## Declaration of Conformity

**Product:** OSDK Expansion Module  
**Model Number:** M300-OEXP01  
**Manufacturer's Name:** *SZ DJI TECHNOLOGY CO., LTD.*  
**Manufacturer's Address:** *14th floor, West Wing, Skyworth Semiconductor Design Building  
NO.18 Gaoxin South 4th Ave, Nanshan District, Shenzhen, Guangdong, China*

We, *SZ DJI TECHNOLOGY CO., LTD.*, declare under our sole responsibility that the above referenced product is in conformity with the applicable requirements of the following directives:

EMC : Electromagnetic Compatibility Regulations 2016  
RoHS : The Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment Regulations 2012

Conformity with these directives has been assessed for this product by demonstrating compliance to the following harmonized standards and/or regulations:

<b>EMC</b>	EN 55032:2015      EN 55035:2017 EN 61000-3-2:2014      EN 61000-3-3:2013
<b>RoHS</b>	The Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment Regulations 2012

Signed for and on behalf of: *SZ DJI TECHNOLOGY CO., LTD.*

Place: Shenzhen, China

Date: 2022-07-21

Name: Gary Zeng

Position: Certification Manager

Signature: